

# Global Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials Market Research Report 2026(Status and Outlook)

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## Abstracts

The 2025 U.S. tariff policies introduce profound uncertainty into the global economic landscape. This report critically examines the implications of recent tariff adjustments and international strategic countermeasures on Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials competitive dynamics, regional economic interdependencies, and supply chain reconfigurations. Electronic packaging specifically includes wafer-level packaging (level 0 packaging), chip-level packaging (level 1 packaging), device and board-level packaging (level 2 packaging), and system-level assembly (level 3 packaging). Among them, the integrated circuit packaging material business belongs to level 0, level 1, and level 2 packaging, the smart terminal packaging material business belongs to level 2 and level 3 packaging, and the new energy application material business belongs to level 3 packaging. Integrated circuit packaging materials run through multiple links such as the design, process, and testing of electronic packaging technology, and directly affect the yield and quality of wafers, chips, and semiconductor devices. Chip-scale packaging (CSP) and board-level packaging (PCB) materials are two important components of semiconductor packaging. Chip-level packaging materials are mainly used to package the chip itself, while board-level packaging materials are used to fix the packaged chip on the circuit board. The main application products of chip-level packaging functional materials are: chip-level bottom filling materials, lid frame bonding materials, and chip-level thermal interface materials. The main application products of board-level packaging materials are: board-level bottom filling materials and board-level thermal interface materials.

The global Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials market size was estimated at USD 1400.0 million in 2025 and is projected to grow at a compound annual growth rate (CAGR) of 11.20% during the forecast period.

This report offers a comprehensive and in-depth analysis of the global Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials market, covering all critical facets from a broad macroeconomic overview to detailed micro-level insights. It examines market size, competitive landscape, emerging development trends, niche segments, key drivers and challenges, as well as conducts SWOT and value chain analyses.

The insights provided enable readers to understand the competitive dynamics within the industry and formulate effective strategies to enhance profitability and market positioning. Additionally, the report presents a clear framework for evaluating the current status and future outlook of business organizations operating in this sector.

A significant focus of this report lies in the competitive landscape of the global Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials market. It offers detailed profiles of major players, including their market shares, performance metrics, product portfolios, and operational status. This enables stakeholders to identify leading competitors and gain a nuanced understanding of market rivalry and structure.

In summary, this report serves as an essential resource for industry participants, investors, researchers, consultants, and business strategists, as well as anyone planning to enter or expand their presence in the Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials market.

### **Global Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials Market: Market Segmentation Analysis**

This research report provides a detailed segmentation of the market by region (country), key manufacturers, product type, and application. Market segmentation divides the overall market into distinct subsets based on factors such as product categories, end-user industries, geographic locations, and other relevant criteria.

A clear understanding of these market segments enables decision-makers to tailor their product development, sales, and marketing strategies more effectively to meet the unique needs of each segment. Leveraging market segmentation insights can significantly enhance targeted approaches, optimize resource allocation, and accelerate product innovation cycles by aligning offerings with the specific demands of diverse customer groups.

## **Key Company**

Shin-Etsu Chemical  
Henkel  
Resonac  
Namics Corporation  
DuPont(Laird Performance Materials)  
Nitto Denko Corporation  
LINTEC Corporation  
Sumitomo Chemical  
H.B.Fuller  
Dow Corning  
Dymax  
DELO Adhesives  
Yongoo Technology Co., Ltd.  
Auzhong Electronics  
Darbond Technology Co., Ltd.

## **Market Segmentation (by Type)**

Chip-level Bottom Filler  
Chip Die-bonding Material  
Lid Frame Bonding Material  
Chip-level Thermal Interface Material  
Board-level Bottom Fill Material  
Board-level Thermal Interface Material

## **Market Segmentation (by Application)**

Consumer Electronics  
Medical Electronics  
Automotive Electronics  
Industrial Electronics  
Communication Equipment & High Performance Computing

## **Geographic Segmentation**

North America (USA, Canada, Mexico)  
Europe (Germany, UK, France, Russia, Italy, Rest of Europe)

Asia-Pacific (China, Japan, South Korea, India, Southeast Asia, Rest of Asia-Pacific)  
South America (Brazil, Argentina, Columbia, Rest of South America)  
The Middle East and Africa (Saudi Arabia, UAE, Egypt, Nigeria, South Africa, Rest of MEA)

### **Key Benefits of This Market Research:**

Industry drivers, restraints, and opportunities covered in the study  
Neutral perspective on the market performance  
Recent industry trends and developments  
Competitive landscape & strategies of key players  
Potential & niche segments and regions exhibiting promising growth covered  
Historical, current, and projected market size, in terms of value  
In-depth analysis of the Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials Market  
Overview of the regional outlook of the Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials Market:

### **Customization of the Report**

In case of any queries or customization requirements, please connect with our sales team, who will ensure that your requirements are met.

### **Chapter Outline**

Chapter 1 mainly introduces the statistical scope of the report, market division standards, and market research methods.

Chapter 2 is an executive summary of different market segments (by region, product type, application, etc), including the market size of each market segment, future development potential, and so on. It offers a high-level view of the current state of the Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials Market and its likely evolution in the short to mid-term, and long term.

Chapter 3 makes a detailed analysis of the market's competitive landscape of the market and provides the market share, capacity, output, price, latest development plan, merger, and acquisition information of the main manufacturers in the market.

Chapter 4 is the analysis of the whole market industrial chain, including the upstream

and downstream of the industry, as well as Porter's five forces analysis.

Chapter 5 introduces the latest developments of the market, the driving factors and restrictive factors of the market, the challenges and risks faced by manufacturers in the industry, and the analysis of relevant policies in the industry.

Chapter 6 provides the analysis of various market segments according to product types, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different market segments.

Chapter 7 provides the analysis of various market segments according to application, covering the market size and development potential of each market segment, to help readers find the blue ocean market in different downstream markets.

Chapter 8 provides a quantitative analysis of the market size and development potential of each region and its main countries and introduces the market development, future development prospects, market space, and capacity of each country in the world.

Chapter 9 shares the main producing countries of Chip-scale Packaging (CSP) and Panel Level Packaging (PLP) Materials, their output value, profit level, regional supply, production capacity layout, etc. from the supply side.

Chapter 10 introduces the basic situation of the main companies in the market in detail, including product sales revenue, sales volume, price, gross profit margin, market share, product introduction, recent development, etc.

Chapter 11 provides a quantitative analysis of the market size and development potential of each region in the next five years.

Chapter 12 provides a quantitative analysis of the market size and development potential of each market segment in the next five years.

Chapter 13 is the main points and conclusions of the report.

### **Key Reasons to Buy this Report:**

Access to date statistics compiled by our researchers. These provide you with historical and forecast data, which is analyzed to tell you why your market is set to change. This enables you to anticipate market changes to remain ahead of your competitors.

You will be able to copy data from the Excel spreadsheet straight into your marketing plans, business presentations, or other strategic documents

The concise analysis, clear graph, and table format will enable you to pinpoint the information you require quickly

Provision of market value data for each segment and sub-segment

Indicates the region and segment that is expected to witness the fastest growth as well as to dominate the market

Analysis by geography highlighting the consumption of the product/service in the region as well as indicating the factors that are affecting the market within each region

Competitive landscape which incorporates the market ranking of the major players, along with new service/product launches, partnerships, business expansions, and acquisitions in the past five years of companies profiled

Extensive company profiles comprising of company overview, company insights, product benchmarking, and SWOT analysis for the major market players

The current as well as the future market outlook of the industry concerning recent developments which involve growth opportunities and drivers as well as challenges and restraints of both emerging as well as developed regions

Includes in-depth analysis of the market from various perspectives through Porter's five forces analysis

Provides insight into the market through Value Chain

Market dynamics scenario, along with growth opportunities of the market in the years to come

6-month post-sales analyst support

### **Customization of the Report**

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